

NPN general purpose double transistor**PUMX1****FEATURES**

- Low current (max. 100 mA)
- Low voltage (max. 40 V)
- Reduces number of components and boardspace.

APPLICATIONS

- General purpose switching and amplification.

DESCRIPTION

Two independently operating NPN transistors in an SC-88 plastic package. PNP complement: PUMT1.

MARKING

TYPE NUMBER	MARKING CODE
PUMX1	ZtZ

PINNING

PIN	DESCRIPTION	
1, 4	emitter	TR1; TR2
2, 5	base	TR1; TR2
3, 6	collector	TR2; TR1

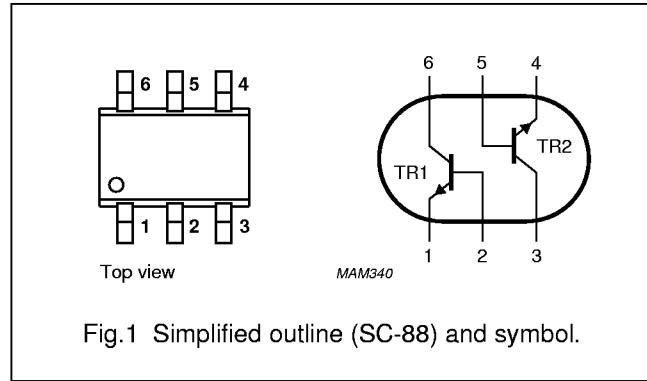


Fig.1 Simplified outline (SC-88) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transistor					
V_{CBO}	collector-base voltage	open emitter	—	50	V
V_{CEO}	collector-emitter voltage	open base	—	40	V
V_{EBO}	emitter-base voltage	open collector	—	5	V
I_C	collector current (DC)		—	100	mA
I_{CM}	peak collector current		—	200	mA
I_{BM}	peak base current		—	200	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$	—	200	mW
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature		—	150	°C
T_{amb}	operating ambient temperature		-65	+150	°C
Per device					
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$; note 1	—	300	mW

Note

1. Device mounted on an FR4 printed-circuit board.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per device				
R _{th j-a}	thermal resistance from junction to ambient	note 1	416	K/W

Note

1. Device mounted on an FR4 printed-circuit board.

CHARACTERISTICST_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transistor					
I _{CBO}	collector cut-off current	I _E = 0; V _{CB} = 30 V	–	100	nA
		I _E = 0; V _{CB} = 30 V; T _j = 150 °C	–	10	µA
I _{EBO}	emitter cut-off current	I _C = 0; V _{EB} = 4 V	–	100	nA
h _{FE}	DC current gain	I _C = 1 mA; V _{CE} = 6 V	120	–	
V _{CEsat}	collector-emitter saturation voltage	I _C = 50 mA; I _B = 5 mA; note 1	–	200	mV
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 12 V; f = 1 MHz	–	1.5	pF
f _T	transition frequency	I _C = 2 mA; V _{CE} = 12 V; f = 100 MHz	100	–	MHz

Note

1. Pulse test: t_p ≤ 300 µs; δ ≤ 0.02.

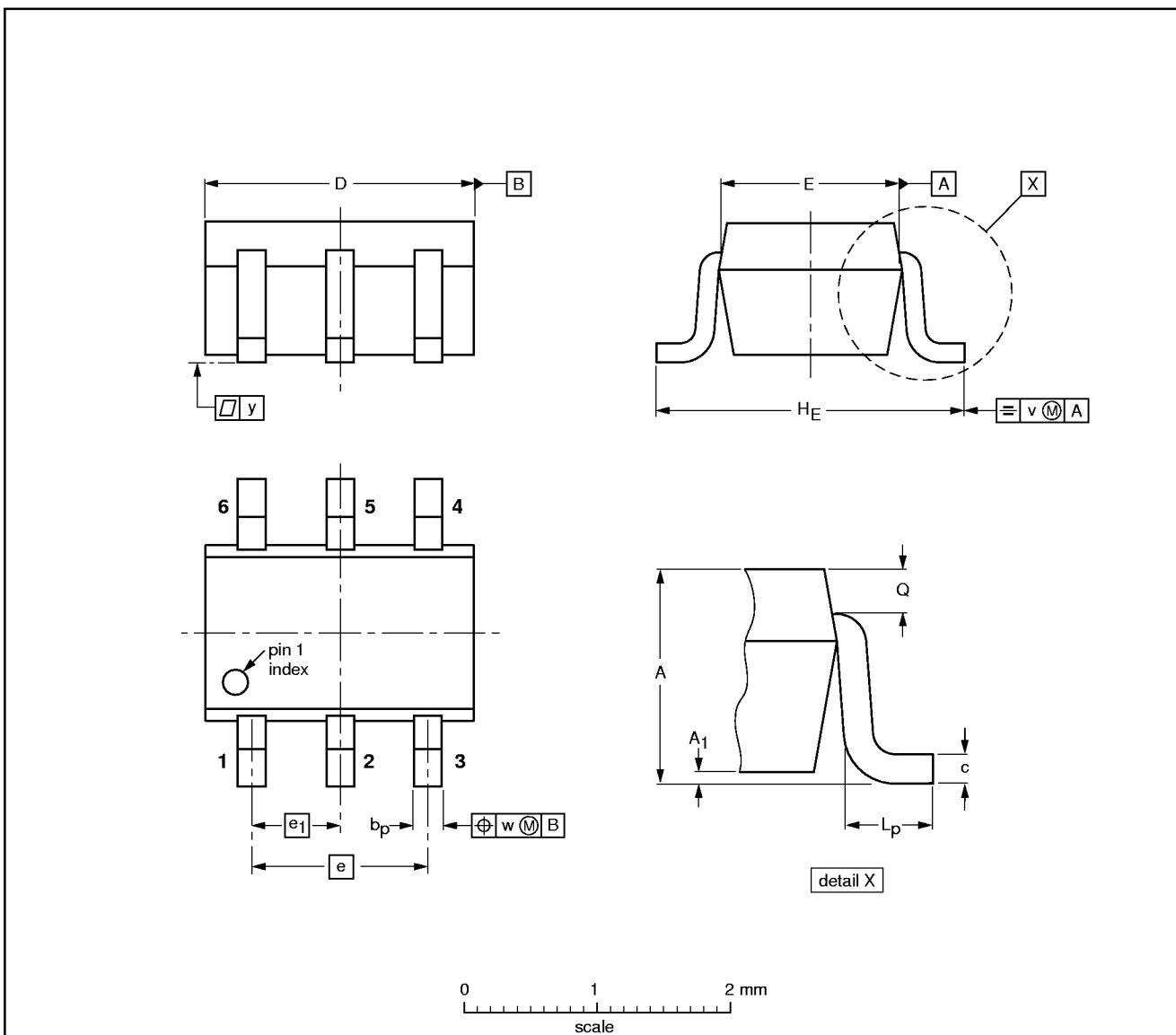
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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT363



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w	y
mm	1.1 0.8	0.1	0.30 0.20	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.25 0.15	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ	SC-88		
SOT363						97-02-28